

Features

- Applications

Optical rangefinders

- **Small package:** $3.1 \times 1.8 \times 1.0^{t}$ mm
- Peak sensitivity wavelength: 840 nm (M=100)
- Low bias operation: Breakdown voltage=195 V max.
- High-speed response: Cutoff frequency=600 MHz typ. (λ=900 nm, M=100)
- Reduction of breakdown voltage variation: 175 ± 20 V

Structure

| Parameter | S14645-02 | S14645-05 | Unit |
|-------------------------------|------------------------------|-----------|-----------------|
| Photosensitive area size*1 | ф0.2 | φ0.5 | mm |
| Effective photosensitive area | 0.03 | 0.19 | mm ² |
| Package | Glass epoxy (silicone resin) | | |

*1: Photosensitive area in which a typical gain can be obtained

Absolute maximum ratings

| Parameter | Symbol | Specification | | |
|-------------------------|--------|-----------------|----|--|
| Reverse current (DC) | IR max | 0.2 | mA | |
| Forward current | IF max | 10 | mA | |
| Operating temperature*2 | Topr | -30 to +100 | °C | |
| Storage temperature*2 | Tstg | -40 to +100 | °C | |
| Soldering temperature | Tsol | 260 (3 times)*3 | °C | |

*2: No dew condensation

When there is a temperature difference between a product and the surrounding area in high humidity environments, dew condensation may occur on the product surface. Dew condensation on the product may cause deterioration in characteristics and reliability.

*3: Reflow soldering, JEDEC J-STD-020 MSL 2a, see P.5

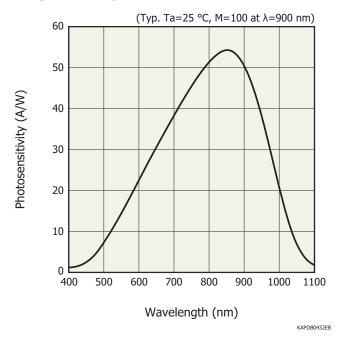
Note: Exceeding the absolute maximum ratings even momentarily may cause a drop in product quality. Always be sure to use the product within the absolute maximum ratings.

1

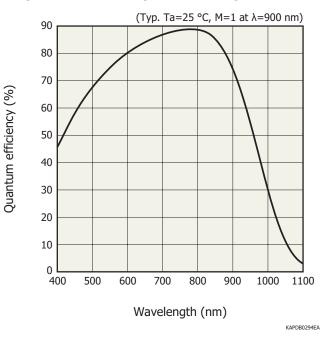
| 2- | Electrical | and | optical | characteristics | (Ta=25 ° | C) |
|----|------------|-----|---------|-----------------|----------|----|
|----|------------|-----|---------|-----------------|----------|----|

| Davanashari | Symbol Condition | Condition | S14645-02 | | S14645-05 | | Linite | | |
|--------------------------------|------------------|-----------------------------------|-----------|------|-----------|--------|--------|------|----------|
| Parameter | | Min. | Тур. | Max. | Min. | Тур. | Max. | Unit | |
| Spectral response range | λ | | | | 400 to | 0 1100 | | | nm |
| Peak sensitivity wavelength | λр | | - | 840 | - | - | 840 | - | nm |
| Photosensitivity | S | λ=900 nm, M=1 | - | 0.5 | - | - | 0.5 | - | A/W |
| Quantum efficiency | QE | λ=900 nm, M=1 | - | 70 | - | - | 70 | - | % |
| Breakdown voltage | Vbr | ID=100 μA | 155 | 175 | 195 | 155 | 175 | 195 | V |
| Temperature coefficient of VBR | ΔTVbr | | - | 1.1 | - | - | 1.1 | - | V/°C |
| Dark current | ID | M=100 | - | 40 | 400 | - | 80 | 800 | pА |
| Temperature coefficient of ID | ΔTid | M=100 | - | 1.1 | - | - | 1.1 | - | times/°C |
| Cutoff frequency | fc | M=100, RL=50 Ω λ=900 nm, -3 dB | - | 600 | - | - | 600 | - | MHz |
| Terminal capacitance | Ct | M=100, f=1 MHz | - | 0.5 | - | - | 1.0 | - | pF |
| Excess noise figure | Х | M=100, λ=900 nm | - | 0.3 | - | - | 0.3 | - | - |
| Gain | М | λ=900 nm | - | 100 | - | - | 100 | - | - |

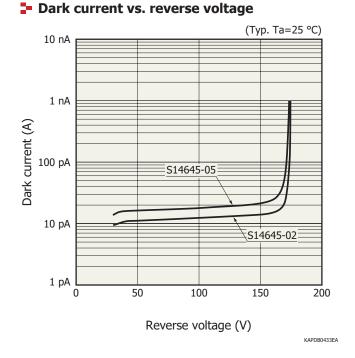
Spectral response



Quantum efficiency vs. wavelength

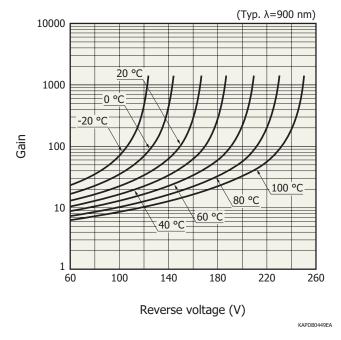






(Typ. Ta=25 °C, f=1 MHz) (Typ. Ta=25 °C, f=1 M

F Gain vs. reverse voltage



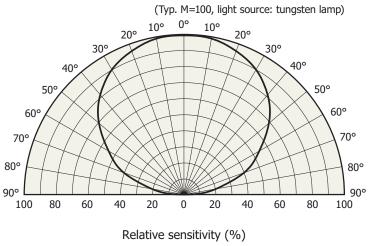


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Terminal capacitance vs. reverse voltage

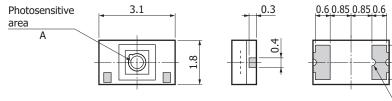
KAPDB0434EA

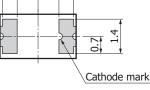




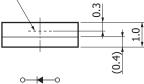
KAPDB0450EA

Dimensional outline (unit: mm)





Photosensitive surface



X, Y $\leq \pm 0.2$

Position accuracy of photosensitive area:



Recommended land pattern

Tolerance unless otherwise noted: ±0.2

| Type no. | А |
|-----------|------|
| S14645-02 | ф0.2 |
| S14645-05 | φ0.5 |

KAPDA0202EA

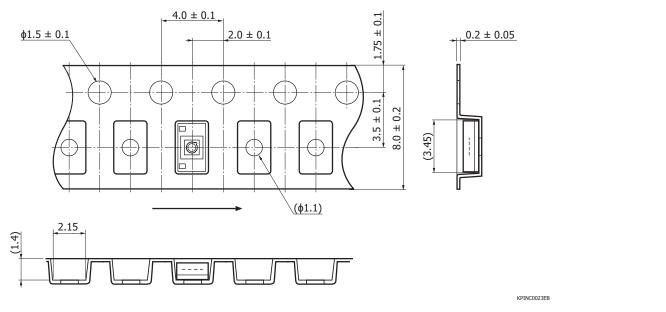


Standard packing specifications

■ Reel (conforms to JEITA ET-7200)

| Outer diameter | Hub diameter | Tape width | Material | Electrostatic characteristics |
|----------------|--------------|------------|----------|-------------------------------|
| φ180 mm | ф60 mm | 8 mm | PS | Conductive |

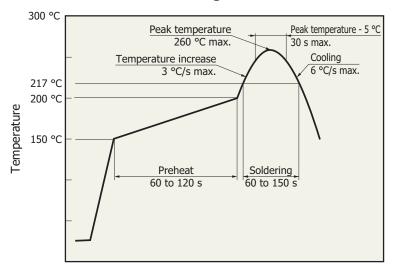
Embossed tape (unit: mm, material: PS, conductive)



Packing quantity 1000 pcs/reel

Packing type

Reel and desiccant in moisture-proof packaging (vaccum-sealed)



Recommended reflow soldering conditions

Time

- After unpacking, store the device in an environment at a temperature of 30 °C or less and a humidity of 60% or less, and perform reflow soldering within 4 weeks.
- The effect that the product receives during reflow soldering varies depending on the circuit board and the reflow oven that are used. When you set reflow soldering conditions, check that problems do not occur in the product by testing out the conditions in advance.

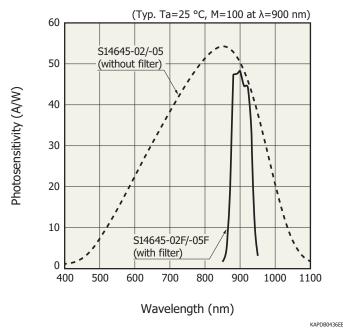
KMPDB0405EC



Related products

Products with on-chip filter that transmits near infrared light (850 to 950 nm) are also available.

Spectral responce



Related information

www.hamamatsu.com/sp/ssd/doc_en.html

- Precautions
- · Disclaimer
- · Surface mount type products
- Technical information
- · Si photodiodes / Technical note

Information described in this material is current as of March 2021.

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